

Delivering Processor Capabilities at MCU Prices

i.MX RT Crossover MCUs







2X (/>)
FASTER
DEVELOPMENT

1/2 X S
THE COST

USHERING IN THE GHZ MCU ERA

NXP's crossover processors and MCUs marry the simplicity of MCUs with the complexity of applications processors into the ultimate hybrid device to address the growing consumer demand for enhanced user experiences in smart, secure, high-performance products. Included in this new class of product is the i.MX RT series of crossover MCUs that combines unprecedented performance - offering the industry's only GHz MCU - with reliability and high levels of integration and security to propel industrial, IoT and automotive applications.

PORTFOLIO HIGHLIGHTS

- Highest performing Arm® Cortex®-M based device
 - Up to 6468 total CoreMarks with Cortex-M7 @ 1GHz + Cortex-M4 @ 400 MHz
- Real-time, low-latency response
 - Up to 2 MB of SRAM
 - 512 KB of TCM with ECC for Cortex-M7
 - 256 KB of TCM with ECC for Cortex-M4
 - Fast real-time response with latency as low as 12 ns
- Low-power operation
 - Industry's lowest dynamic power with integrated DC-DC converter
 - Low-power run modes at 24 MHz
-) Highly integrated
 - Advanced multimedia for GUI and enhanced HMI



- Extensive memory interface options
 - Quad/Octal SPI and Hyper Flash/RAM, SDRAM, NAND Flash, NOR Flash, SD/eMMC
- Security
 - Hardware protected keys for secure boot
 - AES engine for data encryption
 - On-The-Fly Decryption for execute-in-place (XIP) from Quad/Octal SPI / Hyper Flash



i.MX RT CROSSOVER MCUs | PORTFOLIO FEATURES

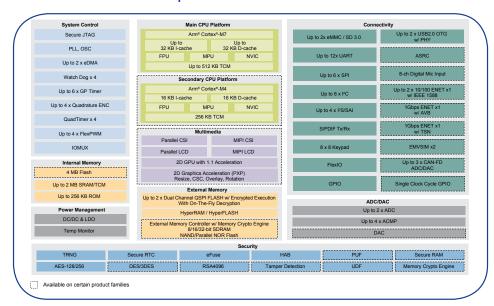
| Feature | i.MX RT1010 | i.MX RT1015 | i.MX RT1020 | i.MX RT1050 | i.MX RT1060/RT1064 | i.MX RT1170 |
|----------------------------------|---|---|---|---|---|---|
| Core/Speed | Cortex-M7 @ 500 MHz | Cortex-M7 @ 500 MHz | Cortex-M7 @ 500 MHz | Cortex-M7 @ 600 MHz | Cortex-M7 @ 600 MHz | Cortex-M7 @ 1GHz, Cortex-M4@ 400 MHz |
| Cache | 16 KB-I, 8 KB-D | 16 KB-I, 16 KB-D | 16 KB-I, 16 KB-D | 32 KB-I, 32 KB-D | 32 KB-I, 32 KB-D | 32 KB-I, 32 KB-D |
| TCM | Up to 128 KB | Up to 128 KB | Up to 256 KB | Up to 512 KB | Up to 512 KB | Up to 512 KB |
| On-chip RAM | 128 KB | 128 KB | 256 KB | 512 KB | 1 MB | 2 MB |
| On-chip Flash | - | - | - | - | Up to 4 MB | - |
| External Memory | - | - | 8-/16-bit interface for SDRAM, SRAM, NOR, NAND | 8-/16-bit interface for SDRAM, SRAM, NOR, NAND | 8-/16-bit interface for SDRAM, SRAM, NOR, NAND | 8-/16-/32-bit interface for SDRAM, SRAM, NOR, NAND |
| Quad/Octal SPI/ HyperBus | Dual-channel/8-bit | Dual-channel/8- bit | Dual-channel/8-bit | Dual-channel/8-bit | Up to 2 x Dual-channel/8- bit | 1 x Dual-channel/8-bit 1 x Dual-channel/16- bit |
| SDIO | - | - | SD3.0/eMMC4.5 x 2 | SD3.0/eMMC4.5 x 2 | SD3.0/eMMC4.5 x 2 | SD3.0/eMMC5.0 x 2 |
| Ethernet | - | - | 10/100 Mbit/s x 1 w/ IEEE 1588 | 10/100 Mbit/s x 1 w/ IEEE 1588 | 10/100 Mbit/s x 2 w/ IEEE 1588 | 1Gbit/s w/ AVB + 1Gbit/s w/ TSN + 10/100 Mbit/s w/ IEEE 1588 |
| USB with PHY | OTG, HS/FS x 1 | OTG, HS/FS x 1 | OTG, HS/FS x 1 | OTG, HS/FS x 2 | OTG, HS/FS x 2 | OTG, HS/FS x 2 |
| CAN | - | - | FlexCAN x 2 | FlexCAN x 2 | FlexCAN x 2 + CANFD x 1 | CAN-FD x 3 |
| Graphics | - | - | - | PxP for 2D acceleration | PxP for 2D acceleration | PxP for 2D acceleration, OpenVG 1.1 |
| CSI | - | - | - | 8-/10-/16-bit parallel | 8-/10-/16-bit parallel | 8-/10-/16- bit parallel, 2-lane MIPI CSI |
| LCD | - | - | - | 8-/16-/18-/24-bit parallel | 8-/16-/18-/24-bit parallel | 8-/16-/18-/24-bit parallel, 2-lane MIPI DSI |
| Security | TRNG, AES-128, SHA, Secure Boot | TRNG, AES-128, SHA, Secure Boot | TRNG, AES-128, SHA, Secure Boot | TRNG, AES-128, SHA, Secure Boot | TRNG, AES-128, SHA, Secure Boot | TRNG,AES-128/256, SHA, Secure Boot, RSA4096, DES/3DES, Tamper Detection PUF, UDF, Secure RAM |
| UART/SPI/I ² C/FlexIO | 4/2/2/1 | 4/2/2/1 | 8/4/4/1 | 8/4/4/2 | 8/4/4/3 | 12/6/6/2 |
| I ² S/SPDIF | 2/1 | 3/1 | 3/1 | 3/1 | 3/1 | 4/1 |
| ADC | 1M sample/s x 1 | 1M sample/s x 1 | 1M sample/s x 2 | 1M sample/s x 2 | 1M sample/s x 2 | 2M sample/s x 2 |
| ACMP/DAC | - | - | 4/- | 4/- | 4/- | 4/1 |
| FlexPWM/Quad Timer/ Quad ENC | 1/0/0 | 1/1/1 | 2/2/2 | 4/4/4 | 4/4/4 | 4/4/4 |
| GP Timer / WDOG | 3/4 | 6/4 | 6/4 | 6/4 | 6/4 | 6/4 |
| Package | 80 LQFP | 100 LQFP | 100 LQFP, 144 LQFP | 196 BGA | 196 BGA | 289 BGA |
| Temperature (Tj) | Consumer: 0 to 95 °C Industrial: -40 to 105 °C | Consumer: 0 to 95 °C Industrial: -40 to 105 °C Automotive: -40 to 125 °C |

MEMORY EXPANSION WITH i.MX RT

i.MX RT crossover MCUs shed the burden of on-chip flash, which not only reduces the cost, but it also enables higher frequency operation for increased performance—which in turn lets you boost capabilities, increase efficiency and add more features. The i.MX RT FlexSPI interface provides memory expansion for external memories such as serial Flash / PSRAM, Quad or Octal data lines. This offers maximum design flexibility, while still ensuring a high-level of performance and security. The i.MX RT series integrates high densities of SRAM, which is further configured within the crossover design architecture to function as TCM with 'zero-wait' single

cycle access to dramatically increase system performance. This key design feature enables the crossover processor's effective performance to be significantly better than any traditional MCU counterpart.

i.MX RT CROSSOVER MCUs | PORTFOLIO BLOCK DIAGRAM



TARGET APPLICATIONS



Audio Subsystem



Consumer Products



Home and Building Automation



Industrial Computing Designs



Motor Control and Power Conversion



Automotive

ACHIEVING END-TO-END SECURITY

Secure development with the i.MX RT leverages years of experience gained from its applications processor lineage. The ROM firmware on the devices, as well as the tools used in the development and manufacturing processes, have been heavily used and tested. With the i.MX RT and its associated software and tools for secure boot, the foundation for meeting today's security requirements can be achieved.

MAXIMUM FLEXIBILITY WITH FlexIO

FlexIO is a highly configurable module providing a wide range of functionality including emulation of a variety of communication protocols such as UART, I²C, SPI, I²S. This means that you have the ultimate flexibility in your design to add more of the peripherals you need. Additionally, the FlexIO module consists of a flexible 16-bit timer with support for a variety of trigger, reset, enable and disable conditions.

i.MX RT CROSSOVER MCUs | SOFTWARE AND TOOLS

NXP's MCUXpresso software and tools offer comprehensive development solutions designed to optimize, ease and accelerate embedded system development of applications based on Cortex-M core devices, including Kinetis and LPC microcontrollers, and i.MX RT crossover MCUs.



NXP eIQ™ Machine Learning Software Development Environment

The NXP eIQ ("edge intelligence") ML software environment provides the key ingredients to do inference with neural network (NN) artificial intelligence (AI) models on embedded systems and deploy various ML algorithms on NXP microprocessors and microcontrollers for edge nodes. It includes inference engines, NN compilers, libraries, and hardware abstraction layers that support Google TensorFlow Lite, Arm NN, Arm® CMSIS-NN, and OpenCV.

GET STARTED NOW

Take advantage of the robust enablement to reduce development effort and speed time-to-market with a comprehensive offering of software and development tools.

The i.MX RT evaluation kits (EVKs) help you take your design to the next level by reducing complexity and accelerating time to market. Additionally, enjoy the ability to expand upon this feature-rich EVK with compatible Arduino TM hardware shields.

Toolchains

- MCUXpresso software and tools
-) IAR® Embedded Workbench® IDE
-) Keil® IDE

Software

- MCUXpresso SDK with Amazon FreeRTOS™
- Zephyr[®] Operating System
- Arm® Mbed™ and the global Arm ecosystem

i.MX RT1010, i.MX RT1015 and i.MX RT1020 EVKs are two-layer through-hole PCBs enabled with a six-axis eCompass sensor, multiple audio features and debug options.

i.MX RT1050, i.MX RT1060 and i.MX RT1064 EVKs are four-layer through-hole PCBs that also offer additional features, including camera and LCD support.

| EVK | i.MX RT1010 | i.MX RT1015 | i.MX RT1020 | i.MX RT1050 | i.MX RT1060/RT1064 |
|------------------|--|---|---|--|--|
| Processor | MIMXRT1011DAE5A | MIMXRT1015DAF5A | MIMXRT1021DAG5A | MIMXRT1052DVL6B | MIMXRT1062DVL6A/ MIMXRT1064DVL6A |
| Memory | 128 Mb QSPI Flash | 128 Mb QSPI Flash | 256 Mb SDRAM memory64 Mb QSPI FlashTF socket for SD card | 256 Mb SDRAM memory 512 Mb Hyper Flash 64 Mb QSPI Flash TF socket for SD card | 256 Mb SDRAM memory512 Mb Hyper Flash64 Mb QSPI FlashTF socket for SD card |
| Display | N/A | N/A | N/A | Parallel LCD connector Camera connector | Parallel LCD connectorCamera Sensor Module |
| Audio | Audio codec 4-pole audio headphone jack External speaker connection Microphone | Audio codec 4-pole audio headphone jack External speaker connection Microphone | Audio codec 4-pole audio headphone jack External speaker connection Microphone | Audio codec 4-pole audio headphone jack External speaker connection Microphone SPDIF connector | Audio codec 4-pole audio headphone jack External speaker connection Microphone SPDIF connector |
| Connectivity | Micro USB OTG connector Arduino® interface | Micro USB OTG connector Arduino® interface | Micro USB host connector Micro USB OTG connector Ethernet (10/100T) connector CAN transceivers Arduino® interface | Micro USB host connector Micro USB OTG connector Ethernet (10/100T) connector CAN transceivers Arduino® interface | Micro USB host connector Micro USB OTG connector Ethernet (10/100T) connector CAN transceivers Arduino® interface |
| Debug | JTAG connectorOnboard DAP-link debugger | JTAG connectorOnboard DAP-link debugger | JTAG connectorOnboard DAP-link debugger | JTAG connectorOnboard DAP-link debugger | JTAG connectorOnboard DAP-link debugger |
| Sensor | 6-axis eCompass (3-axis magnetometer, 3-axis accelerometer) sensor FXOS8700CQ | 6-axis eCompass (3-axis magnetometer, 3-axis accelerometer) sensor FXOS8700CQ | 6-axis eCompass (3-axis magnetometer, 3-axis accelerometer) sensor FXOS8700CQ | 6-axis eCompass (3-axis magnetometer, 3-axis accelerometer) sensor FXOS8700CQ | 6-axis eCompass (3-axis magnetometer, 3-axis accelerometer) sensor FXOS8700CQ |
| Part Number | MIMXRT1010-EVK | MIMXRT1015-EVK | MIMXRT1020-EVK | IMXRT1050-EVKB | MIMXRT1060-EVK/ MIMXRT1064-EVK |
| Camera Sensor | N/A | N/A | N/A | N/A | MT9M114 image sensor (included) |
| Display | N/A | N/A | N/A | RK043FN02H-CT 4.3" (purchased separately) | RK043FN02H-CT 4.3" (purchased separately) |
| | i.MX RT1010 | i.MX RT1015 | i.MX RT1020 | i.MX RT1050 | i.MX RT1060/RT1064 |



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